

Title (en)
CHIP CARD AND METHOD FOR PRODUCING A CHIP CARD OF THIS TYPE

Title (de)
CHIPKARTE SOWIE EIN VERFAHREN ZUR HERSTELLUNG EINER DERARTIGEN CHIPKARTE

Title (fr)
CARTE A PUCE ET SON PROCEDE DE PRODUCTION

Publication
EP 1433128 A1 20040630 (DE)

Application
EP 02779136 A 20021001

Priority
• DE 0203741 W 20021001
• DE 10148525 A 20011001

Abstract (en)
[origin: DE10148525A1] Chip card consists of a chip card body with a conductor strip in the form of a coil (1) made from an electrically conducting plastic or metal powder produced by injection molding or embossing. An Independent claim is also included for a process for the production of a chip card. Preferred Features: The plastic is a thermoplastic material. The metal powder has a globular structure and contains an electrically conducting binder. The coil is integrated into the chip card body of the card. The coil has protrusions (9) which extend up to a cavity arranged in a plane above the coil and form an connecting contact for a chip module.

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G06K 19/077; **B29C 45/14**

IPC 8 full level
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See references of WO 03032245A1

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